ABBOCIATION CONNECTING ELECTRONICS INDUSTRIES® INFORMATION CONNECTING	PC, Bannock	burn, Illinois. A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declar the declaratio	ration of n encon	f the substance npasses all low	es withir wer level	the manufac materials for	turer listed i which the n	tem. No nanufac	ote: if the	e item is an as s engineering	sembly with low responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Ty http://www.ipc.org/IPC-175x Distribution				e *	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					erials and M	ials and Mfg Information				
Supplier Information																
Company name*	Company unique ID			Unique ID Authority					Respons	Response Date*						
onsemi											2024-05	2024-05-03				
			Title - Contact			Phone - Contact*					Email -	Email - Contact*				
Product-Env-Stewards	Product Enviro Compliance				NA					Produc	Product-Env-Stewards@onsemi.com					
authorized Representative*	Title - Repres	Title - Representative			Phone - Representative*				Email -	Email - Representative*						
Product-Env-Stewards	Product Enviro Compliance				NA				Produc	Product-Env-Stewards@onsemi.com						
Requester Item Number	Mfr Iten	n Number	r Mfr Item Name ULP-A Dual Inverter			Effective Date 2024-05-03		ersion	Manufacturing Site   THB		,	Weight	*	UOM	Unit Type	
	NC7WV	/04L6X										2.086814		mg	Each	
Aanufacturing Proccess Informa	tion								-						I	
Terminal Plating / Grid Array M	aterial	Ferminal Base A	Alloy	J-STD-020 MSL Rating		Peak Process B		Body Temperature Max Time at Peal		ak Temperat	Temperature Number		of Reflow Cyc	les		
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		CU Alloy 1		1		260		С	30	30		ids 3	6			
comments																
evel 1 - maximum time at peak temperat	ure during so	ldering is 10-3	0 seconds													
or more information regarding material	composition	please refer to	page 3													

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.04	mg	Supplier	Silicon (Si)	7440-21-3		0.04	mg
Die Attach Tape	0.003	mg	Supplier	Oxirane, (chloromethyl)-, homopolymer	24969-06-0		0.0005	mg
			Supplier	2-Propenoic acid, 2-methyl-, polymer with butyl 2-propenoate and methyl 2- methyl-2-propenoate	25035-69-2		0.0005	mg
			Supplier	Proprietary	Proprietary Data		0.0003	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.0013	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.0005	mg
Lead Frame	0.802872	mg	Supplier	Magnesium (Mg)	7439-95-4		0.001	mg
			Supplier	Silicon (Si)	7440-21-3		0.0063	mg
			В	Nickel (Ni)	7440-02-0		0.0261	mg
			Supplier	Copper (Cu)	7440-50-8		0.7695	mg
Mold Compound-Black	1.204	mg		Epoxy resin	proprietary data		0.0602	mg
			Supplier	Phenolic Resin	Proprietary Data		0.0277	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.0602	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0048	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.0277	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		1.0234	mg
Plating	0.024942	mg	Supplier	Silver (Ag)	7440-22-4		0.0001	mg
			Supplier	Palladium (Pd)	7440-05-3		0.0002	mg
			В	Nickel (Ni)	7440-02-0		0.0246	mg
			Supplier	Gold (Au)	7440-57-5		0.0001	mg
Wire Bond	0.012	mg	Supplier	Palladium (Pd)	7440-05-3		0.0002	mg
			Supplier	Gold (Au)	7440-57-5		0	mg
			Supplier	Copper (Cu)	7440-50-8		0.0117	mg